

10A, 100V - 200V Schottky Barrier Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- Guard ring for overvoltage protection
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Low voltage, high freq. inverter
- DC/DC converter
- Freewheeling diodes
- Reverse battery protection
- Car lighting

MECHANICAL DATA

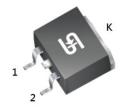
- Case: TO-263AB (D²PAK)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 1.40g (approximately)

| KEY PARAMETERS | | | |
|--------------------|-------------------------------|------|--|
| PARAMETER | VALUE | UNIT | |
| I _F | 10 | Α | |
| V_{RRM} | 100 - 200 | V | |
| I _{FSM} | 120 | Α | |
| T _{J MAX} | 175 | °C | |
| Package | TO-263AB (D ² PAK) | | |
| Configuration | Dual dies | | |









TO-263AB (D²PAK)



| ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted) | | | | | |
|--|------------------|-----------------------|-----------------------|-----------------------|------|
| PARAMETER | SYMBOL | MBRS 10H100CT H | MBRS 10H150CT H | MBRS 10H200CT H | UNIT |
| Marking code on the device | | MBRS 10H100CT | MBRS 10H150CT | MBRS 10H200CT | |
| Repetitive peak reverse voltage | V_{RRM} | 100 | 150 | 200 | V |
| Reverse voltage, total rms value | $V_{R(RMS)}$ | 70 | 105 | 140 | V |
| Forward current | l _F | 10 | | | Α |
| Surge peak forward current, 8.3ms single half sine wave superimposed on rated load | I _{FSM} | 120 | | | Α |
| Peak repetitive forward current (Rated V _R , Square wave, 20KHz) | I _{FRM} | 10 | | А | |
| Peak repetitive reverse surge current ⁽¹⁾ | I _{RRM} | 1 0.5 | | Α | |
| Critical rate of rise of off-state voltage | dv/dt | 10,000 | | V/µs | |
| Junction temperature | TJ | -55 to +175 | | °C | |
| Storage temperature | T _{STG} | -55 to +175 | | | °C |

Notes:

1. $tp = 2.0\mu s$, 1.0KHz



MBRS10H100CTH - MBRS10H200CTH

Taiwan Semiconductor

| THERMAL PERFORMANCE | | | |
|-------------------------------------|------------------|-----|------|
| PARAMETER | SYMBOL | TYP | UNIT |
| Junction-to-case thermal resistance | R _{eJC} | 3.5 | °C/W |

| ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted) | | | | | | |
|--|--------------------------------|---|------------------|-----|------|------|
| PARAMETER | | CONDITIONS | SYMBOL | TYP | MAX | UNIT |
| | MBRS10H100CTH | | | - | 0.85 | V |
| | MBRS10H150CTH MBRS10H200CTH | $I_F = 5A, T_J = 25^{\circ}C$ | | - | 0.88 | V |
| | MBRS10H100CTH | | | - | 0.95 | V |
| Forward voltage | MBRS10H150CTH MBRS10H200CTH | $I_F = 10A, T_J = 25^{\circ}C$ | V_F | - | 0.97 | V |
| per diode ⁽¹⁾ | MBRS10H100CTH | I _F = 5A, T _J = 125°C | ٧F | - | 0.75 | V |
| | MBRS10H150CTH MBRS10H200CTH | | | - | 0.75 | V |
| | MBRS10H100CTH | | | - | 0.85 | ٧ |
| | MBRS10H150CTH MBRS10H200CTH | $I_F = 10A, T_J = 125^{\circ}C$ | | - | 0.85 | V |
| Reverse current @ rated V _R per diode ⁽²⁾ | | $T_J = 25^{\circ}C$ | · I _R | - | 5 | μΑ |
| | | T _J = 125°C | | - | 1 | mA |

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

| ORDERING INFORMATION | | |
|------------------------------|-------------------------------|-------------------|
| ORDERING CODE ⁽¹⁾ | PACKAGE | PACKING |
| MBRS10HxCTH | TO-263AB (D ² PAK) | 800 / Tape & Reel |

Notes:

1. "x" defines voltage from 100V(MBRS10H100CTH) to 200V(MBRS10H200CTH)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

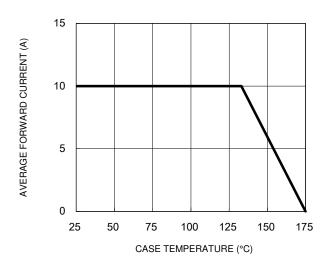


Fig.2 Typical Junction Capacitance

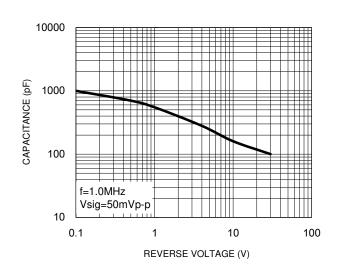
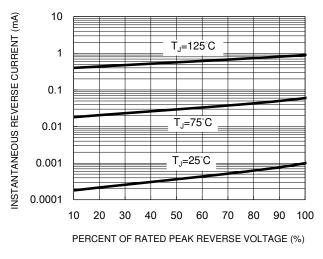


Fig.3 Typical Reverse Characteristics

Fig.4 Typical Forward Characteristics



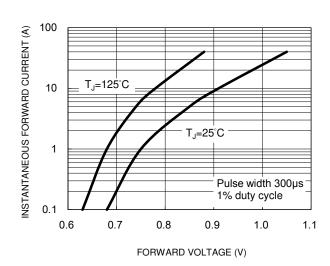
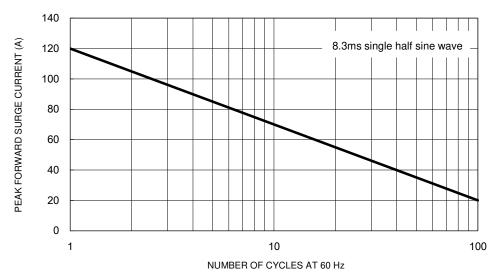


Fig.5 Maximum Non-Repetitive Forward Surge Current

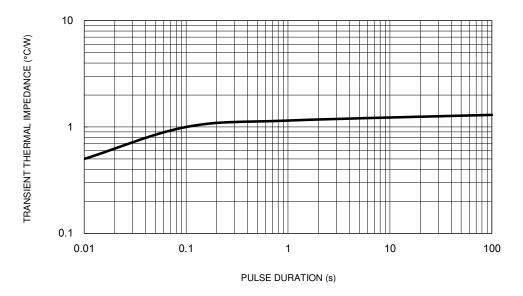


Taiwan Semiconductor

CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

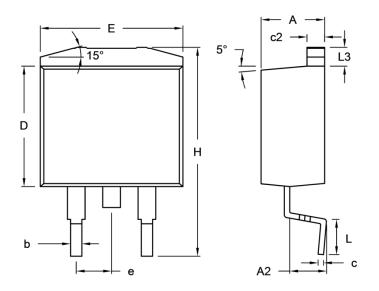
Fig.6 Typical Transient Thermal Impedance



Taiwan Semiconductor

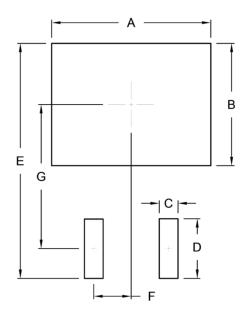
PACKAGE OUTLINE DIMENSIONS

TO-263AB (D²PAK)



| DIM. | Unit (mm) | | Unit (| (inch) |
|------|-----------|-----------|--------|--------|
| DIN. | Min. | Min. Max. | | Max. |
| Α | 4.44 | 4.70 | 0.175 | 0.185 |
| A2 | 2.03 | 2.79 | 0.080 | 0.110 |
| b | 0.68 | 0.94 | 0.027 | 0.037 |
| С | 0.36 | 0.53 | 0.014 | 0.021 |
| c2 | 1.14 | 1.40 | 0.045 | 0.055 |
| D | 8.25 | 9.25 | 0.325 | 0.364 |
| E | - | 10.50 | - | 0.413 |
| е | 2.41 | 2.67 | 0.095 | 0.105 |
| Н | 14.60 | 15.88 | 0.575 | 0.625 |
| L | 2.29 | 2.79 | 0.090 | 0.110 |
| L3 | 1.14 | 1.40 | 0.045 | 0.055 |

SUGGESTED PAD LAYOUT



| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| Α | 10.80 | 0.425 |
| В | 8.30 | 0.327 |
| С | 1.27 | 0.050 |
| D | 4.05 | 0.159 |
| E | 15.95 | 0.628 |
| F | 2.54 | 0.100 |
| G | 9.775 | 0.385 |

MARKING DIAGRAM



P/N = Marking Code G = Green Compound

YWW = Date Code F = Factory Code



Taiwan Semiconductor

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.